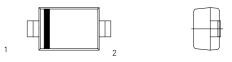
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SBD Type: EP05Q04

FEATURES

- * JEDEC SOD-123 Package
- * Very Low profile 1.1mm Max
- * Low Forward Voltage Drop
- * Low Power Loss, High Efficiency
- * High Surge Capability
- * Low Thermal Resistance
- * Packaged in 8mm Tape and Reel







Maximum Ratings

Approx Net Weight:0.011g

Rating	Symbol	EP05Q04			Unit	
Repetitive Peak Reverse Voltage	V _{RRM}	40			V	
Average Rectified Output Current	I_{O}	0.43	Ta=25°C * 1	50Hz Half Sine Wave,	A	
		0.50	Tl=110°C	Resistive Load		
RMS Forward Current	I _F (RMS)	0.785			A	
Surge Forward Current	I _{FSM}	8	50Hz Half Sine	A		
			Non-repetitive			
Operating JunctionTemperature Range	T_{jw}	-40 to +150			$^{\circ}\mathrm{C}$	
Storage Temperature Range	Tstg	-40 to +150			°C	

Electrical • Thermal Characteristics

Characteristics	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Peak Reverse Current	I_{RM}	Tj= 25°C, V _{RM} = V _{RRM}	-	-	100	μΑ	
Peak Forward Voltage	$V_{\rm FM}$	Tj= 25°C, I _{FM} =0.5A	-	-	0.51	V	
Thermal Resistance	Rth _(j-a)	Junction to Ambient *	-	-	300	°C/W	
	Rth _(j-l)	Junction to Lead	-	-	70	C/VV	

^{*1:} Glass Epoxy Substrate Mounted (Soldering Lands=1x1mm,Both Sides)

(Tl: Lead Temperature)

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EP05Q04 OUTLINE DRAWING (Dimensions in mm)

